

6<sup>th</sup> South-East Europe Design Automation, Computer Engineering, Computer Networks and Social Media Conference

# SEEDA-CECNSM 2021

September 24-26, 2021, Preveza, Greece

https://seeda2021.uowm.gr/



# Dear authors,

We cordially invite you to submit your papers and attend the IEEE – 6th South-East Europe Design Automation, Computer Engineering, Computer Networks and Social Media Conference, which will be held in Preveza, Greece, September 24<sup>th</sup>-26<sup>th</sup> 2021, and it will be jointly organized by the *Department of Electrical & Computer Engineering, University of Western Macedonia*, Greece, (<a href="https://www.uowm.gr/en">https://www.uowm.gr/en</a>) and the *Departments of Informatics & Telecommunications and Accounting & Finance, University of Ioannina*, Greece (<a href="https://www.uoi.gr/en">https://www.uoi.gr/en</a>). The conference will be hybrid, allowing physical and online attendance.

The South-East Europe Design Automation, Computer Engineering, Computer Networks and Social Media Conference (SEEDA-CECNSM 2021), in its 6th year, will provide an insight into the unique world stemming from the interaction between the fields of computer engineering, networks and Design Automation. SEEDA-CECNSM 2021 will provide an international technical forum for experts from the engineering industry and academia to exchange ideas, innovations, and present results of on-going research in the most state-of-the-art areas. The conference covers many topics under areas of Design Automation, Computer Engineering and Computer Networks (a detailed list of topics can be found in: <a href="https://seeda2021.uowm.gr/">https://seeda2021.uowm.gr/</a>).

SEEDA-CECNSM 2021 will be technically co-sponsored by the IEEE Computational Intelligence Society and all papers will be indexed by IEEE Xplore, DBLP and Scopus.

## <u>Important dates:</u>

Submission of full papers: May 31, 2021

Notification of acceptance: July 5, 2021

Submission of camera ready: July 31, 2021

Main Conference: September 24-26, 2021

### **Proceedings/Publications**

Extended versions of selected papers will be included in a Special Issue of the *Telecom* MDPI internationally indexed (dblp, Scopus, ESCI, Google Scholar) journal, on a special, 100% APC-waived submission status.

Regards,

Conference Organizing Team,

**SEEDA-CECNSM 2021** 

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